

# P-Channel Enhancement Mode Vertical DMOS FETs

#### **Features**

- ► Low threshold (-2.4V max.)
- High input impedance
- ► Low input capacitance (125pF max.)
- Fast switching speeds
- Low on-resistance
- Free from secondary breakdown
- Low input and output leakage

### **Applications**

- Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- ▶ Telecom switches

### **General Description**

This low threshold enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### **Ordering Information**

Dovice	Package Op	otions	BV <sub>DSS</sub> /BV <sub>DGS</sub>	$R_{\scriptscriptstyle DS(ON)}$	V <sub>GS(TH)</sub>	D(ON)
Device	TO-243AA (SOT-89)	Die*	(V)	(Ω)	(max) (V)	(min) (A)
TP2510	TP2510N8-G	TP2510ND	-100	3.5	-2.4	-1.5

<sup>-</sup>G indicates package is RoHS compliant ('Green')

<sup>\*</sup> MIL visual screening available





## **Absolute Maximum Ratings**

Parameter	Value
Drain-to-source voltage	BV <sub>DSS</sub>
Drain-to-gate voltage	BV <sub>DGS</sub>
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C
Soldering temperature*	300°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## **Pin Configuration**



TO-243AA (SOT-89) (N8)

## **Product Marking**



W = Code for Week Sealed
\_\_\_\_ = "Green" Packaging

Package may or may not include the following marks: Si or

TO-243AA (SOT-89) (N8)

Distance of 1.6 mm from case for 10 seconds.

### **Thermal Characteristics**

Package	l <sub>D</sub> (continuous) <sup>†</sup> (mA)	I <sub>D</sub> (pulsed) (A)	Power Dissipation @ T <sub>A</sub> = 25°C (W)	<b>θ</b> <sub>jc</sub> (°C/W)	θ <sub>ja</sub> (°C/W)	l <sub>DR</sub> <sup>†</sup> (mA)	I <sub>DRM</sub> (A)	
TO-243AA	-480	-2.5	1.6 <sup>‡</sup>	15	78 <sup>‡</sup>	-480	-2.5	

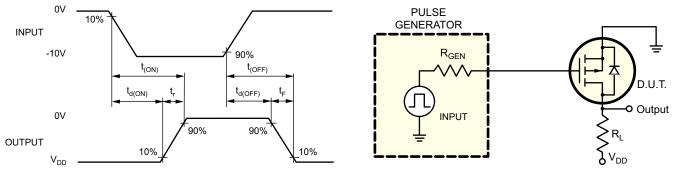
# **Electrical Characteristics** (T<sub>A</sub> = 25°C unless otherwise specified)

Sym	Parameter	Min	Тур	Max	Units	Conditions		
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	-100	-	-	V	$V_{GS} = 0V, I_{D} = -2.0 \text{mA}$		
V <sub>GS(th)</sub>	Gate threshold voltage	-1.0	-	-2.4	V	$V_{GS} = V_{DS}$ , $I_D = -1.0$ mA		
$\Delta V_{GS(th)}$	Change in V <sub>GS(th)</sub> with temperature	-	-	5.0	mV/°C	$V_{GS} = V_{DS}$ , $I_D = -1.0$ mA		
I <sub>GSS</sub>	Gate body leakage	-	-	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
			-	-10	μA	$V_{GS} = 0V, V_{DS} = Max Rating$		
I <sub>DSS</sub>	Zero gate voltage drain current	-	-	-1.0	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_{A} = 125$ °C		
	On state drain surrent	-0.4	-0.6	-	Α	$V_{GS} = -5.0V, V_{DS} = -25V$		
I <sub>D(ON)</sub>	On-state drain current	-1.5	-2.5	-	A	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -25V		
В	Ctatia duain to accuracy and attachment	-	5.0	7.0		V <sub>GS</sub> = -5.0V, I <sub>D</sub> = -250mA		
R <sub>DS(ON)</sub>	Static drain-to-source on-state resistance		2.0	3.5	Ω	V <sub>GS</sub> = -10V, I <sub>D</sub> = -750mA		
$\Delta R_{DS(ON)}$	Change in R <sub>DS(ON)</sub> with temperature		-	1.7	%/°C	V <sub>GS</sub> = -10V, I <sub>D</sub> = -750mA		
G <sub>FS</sub>	Forward transconductance	300	360	-	mmho	V <sub>DS</sub> = -25V, I <sub>D</sub> = -750mA		
C <sub>ISS</sub>	Input capacitance	-	80	125		V <sub>GS</sub> = 0V,		
C <sub>oss</sub>	Common source output capacitance	-	40	70	pF	$V_{DS} = -25V,$		
C <sub>RSS</sub>	Reverse transfer capacitance	-	10	25		f = 1.0 MHz		
t <sub>d(ON)</sub>	Turn-on delay time	_	-	10				
t,	Rise time	-	-	15		$V_{DD} = -25V,$		
t <sub>d(OFF)</sub>	Turn-off delay time	-	-	20	ns	$\begin{vmatrix} I_D = -1.0A, \\ R_{GEN} = 25\Omega \end{vmatrix}$		
$t_{f}$	Fall time	-	-	15		GEN 2032		
V <sub>SD</sub>	Diode forward voltage drop	-	-	-1.8	V	$V_{GS} = 0V, I_{SD} = -1.0A$		
t <sub>rr</sub>	Reverse recovery time	-	300	-	ns	$V_{GS} = 0V, I_{SD} = -1.0A$		

#### Notes:

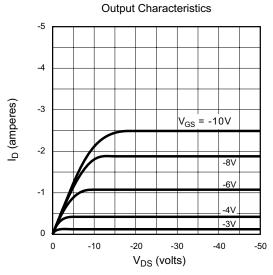
- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
   All A.C. parameters sample tested.

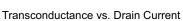
# **Switching Waveforms and Test Circuit**

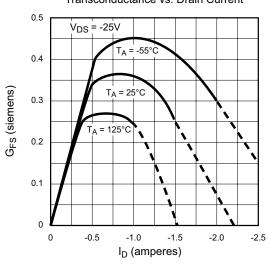


<sup>†</sup>  $I_{\scriptscriptstyle D}$  (continuous) is limited by max rated  $T_{\scriptscriptstyle f}$  ‡ Mounted on FR5 board, 25mm x 25mm x 1.57mm.

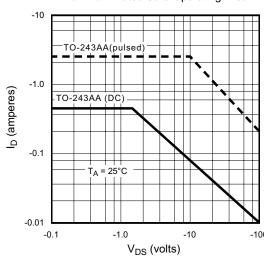
## **Typical Performance Curves**



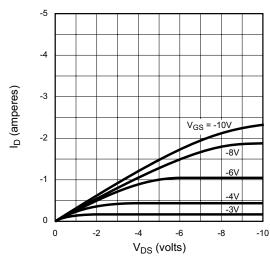




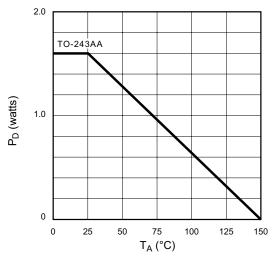
#### Maximum Rated Safe Operating Area



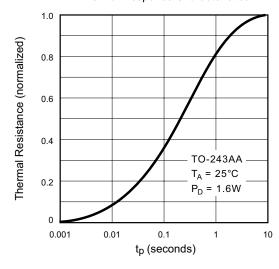
#### Saturation Characteristics



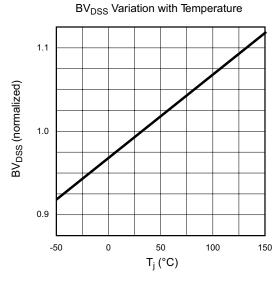
#### Power Dissipation vs. Ambient Temperature

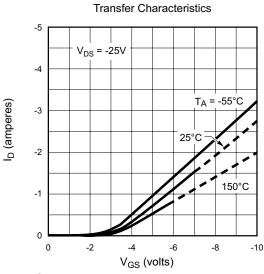


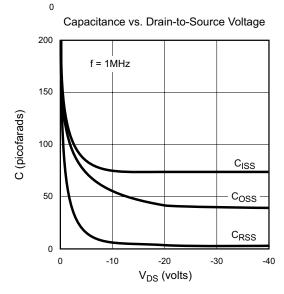
#### Thermal Response Characteristics

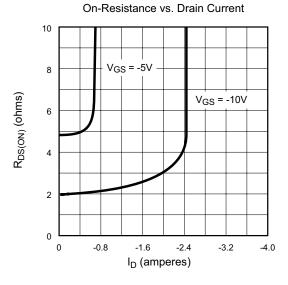


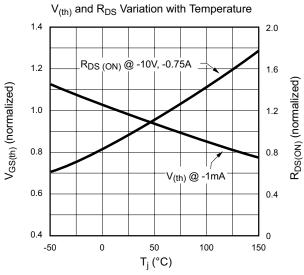
## **Typical Performance Curves** (cont.)

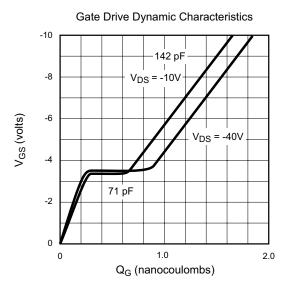




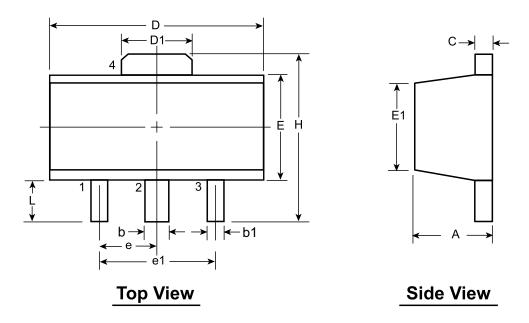








# 3-Lead TO-243AA (SOT-89) Package Outline (N8)



Symbo	ol	Α	b	b1	С	D	D1	Е	E1	е	e1	Н	L
	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.13	1.50 BSC	3.00 BSC	3.94	0.89
Dimensions (mm)	NOM	-	-	-	-	-	-	-	-			-	-
(,	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

Drawings not to scale.

Supertex Doc. #: DSPD-3TO243AAN8, Version D070908.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <a href="http://www.supertex.com/packaging.html">http://www.supertex.com/packaging.html</a>.)

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